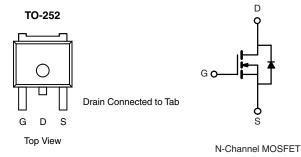


Vishay Siliconix

Automotive N-Channel 30 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0031				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0040				
I _D (A)	50				
Configuration	Single				



FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- AEC-Q101 Qualified^d
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>



COMPLIANT HALOGEN

ORDERING INFORMATION	
Package	TO-252
Lead (Pb)-free and Halogen-free	SQD50N03-4m0L-GE3

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless	s otherwise noted	ł)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current ^a	T _C = 25 °C	I	50	A	
	T _C = 125 °C	I _D	50		
Continuous Source Current (Diode Conductio	n) ^a	I _S	50		
Pulsed Drain Current ^b		I _{DM}	125		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	60		
Single Pulse Avalanche Energy		E _{AS}	180	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	T _C = 25 °C	136	W	
	T _C = 125 °C	P _D	45	vv	
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)		R _{thJC}			

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR-4 material).

d. Parametric verification ongoing.

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		30	-	-	v
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	2.5	v
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 30 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 175 °C	-	-	150	1
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	50	-	-	Α
		$V_{GS} = 10 V$	I _D = 20 A	-	0.0027	0.0031	Ω
Drain-Source On-State Resistance ^a	Б	$V_{GS} = 10 V$	$I_D = 20 \text{ A}, \text{T}_\text{J} = 125 \ ^\circ\text{C}$	-	-	0.0048	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	-	-	0.0056	
		$V_{GS} = 4.5 V$	I _D = 15 A	-	0.0031	0.0040	
Forward Transconductanceb	9 _{fs}	V _{DS}	V _{DS} = 15 V, I _D = 20 A		122	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V V _{DS} = 15 V, f = 1 MHz	-	5053	6316	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	921	1151	
Reverse Transfer Capacitance	C _{rss}			-	377	471	
Total Gate Charge ^c	Qg			-	77	116	
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = 10 V$	$V_{DS} = 15 \text{ V}, I_{D} = 50 \text{ A}$	-	14.3	-	nC
Gate-Drain Charge ^c	Q _{gd}	1		-	11	-	
Gate Resistance	R _g	f = 1 MHz		1.14	2.28	3.42	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	10	15	
Rise Time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{DD} = 15 \text{ V}, \text{ R}_L = 0.3 \ \Omega \\ \text{I}_D \cong 50 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \ \Omega \end{array}$		-	10	15	
Turn-Off Delay Time ^c	t _{d(off)}			-	42	63	- ns
Fall Time ^c	t _f			-	10	15	
Source-Drain Diode Ratings and Char	acteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	125	Α
Forward Voltage	V _{SD}	I _F = 40 A, V _{GS} = 0 V		-	0.85	1.2	V

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

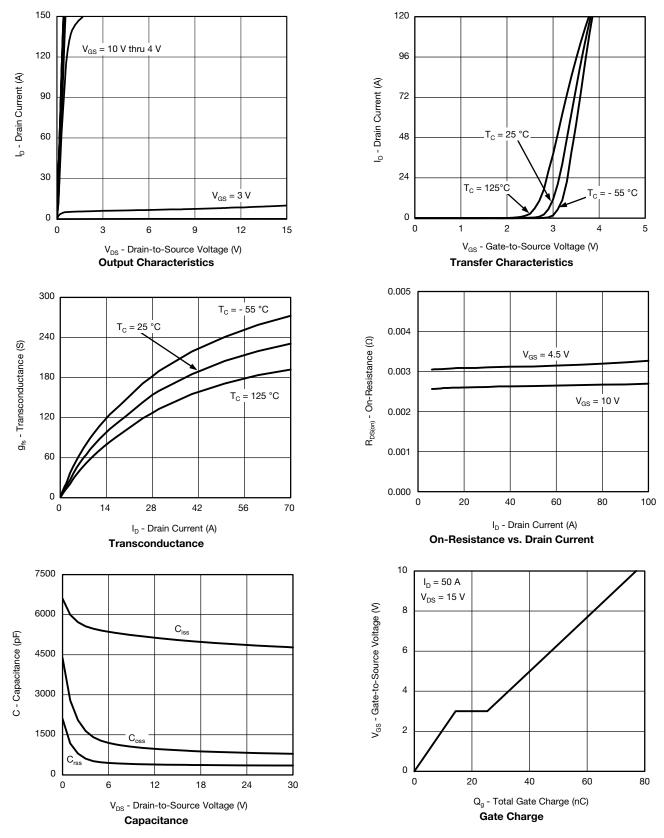
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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T_J = 25 °C

0.8

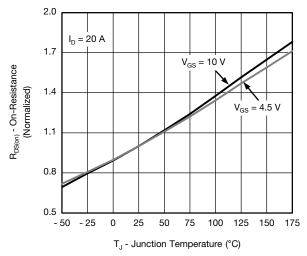
1.0

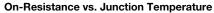
1.2

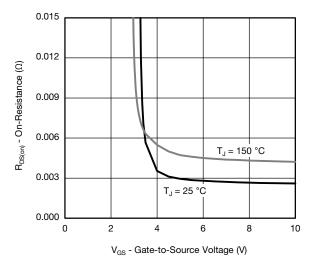


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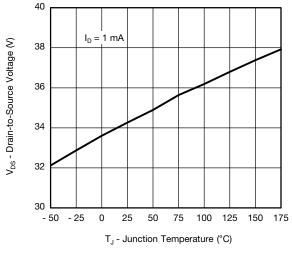
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

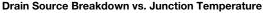






On-Resistance vs. Gate-to-Source Voltage





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V_{SD} - Source-to-Drain Voltage (V) Source Drain Diode Forward Voltage

0.6

0.4

100

10

1

0.1

0.01

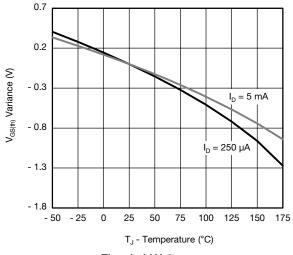
0.001

0.0

0.2

I_s - Source Current (A)

T_J = 150 °C

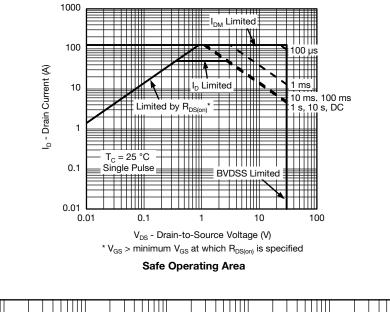


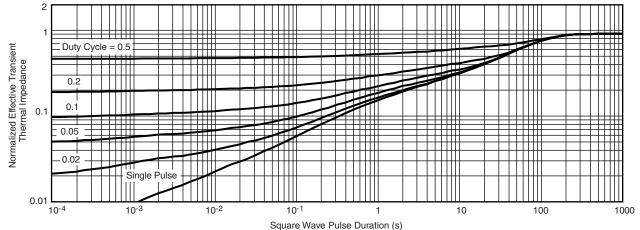
Threshold Voltage



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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Normalized Thermal Transient Impedance, Junction-to-Ambient

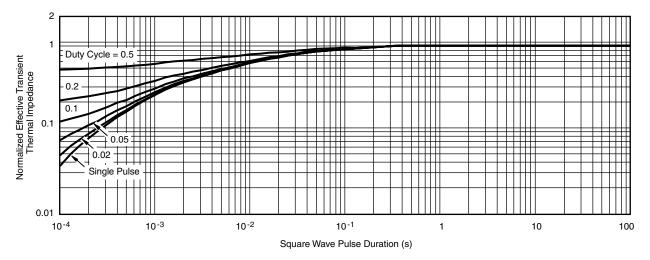
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

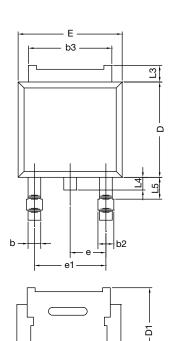
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67472.

Document Number: 67472







E1

TO-252AA Case Outline

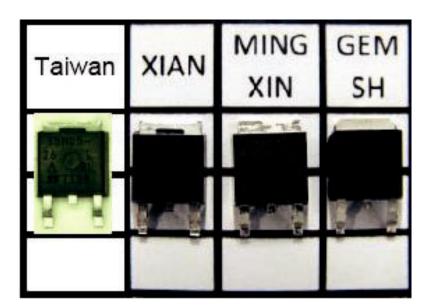
	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0359-Rev. O, 03-Jun-13 DWG: 5347					

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Notes

• Dimension L3 is for reference only.

• Xi'an, Mingxin, and GEM SH actual photo.



Revision: 03-Jun-13

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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